Package Outline

1) Dimension applies to plated terminals
Recommendations for solder mask openings and microvia dimensions

Position tolerance = 0.2 mm max.

Microvia diameter = 0.1 mm
Recommendations for copper pad and via dimensions

Soldering Type: Reflow Soldering

Via position tolerance = 0.4 mm max.

Via diameter = 0.2 mm
Marking Layout

Tape and Reel

Reel ø180 mm: 3,000 Pieces/Reel
Reels/Box: